SDLS089

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

These devices contain three independent 3-input NOR gates.

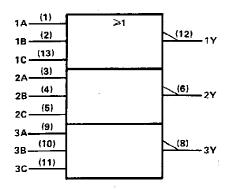
The SN5427 and SN54LS27 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7427 and SN74LS27 are characterized for operation from 0 °C to 70 °C.

FUNCTION TABLE (each gate)

11	NPUT	s	OUTPUT
А	B	С	Y
Н	х	x	Ļ
х	Н	x	L
х	х	н	L
L	L	L	н

logic symbol[†]

÷,

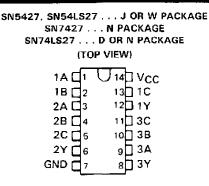


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

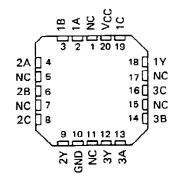
Pin numbers shown are for D, J, N, and W packages.

SN5427, SN54LS27, SN7427, SN74LS27 TRIPLE 3-INPUT POSITIVE-NOR GATES

DECEMBER 1983-REVISED MARCH 1988

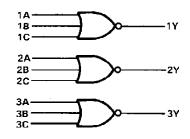


SN54LS27 FK PACKAGE (TOP VIEW)



NC - No internal connection

logic diagram



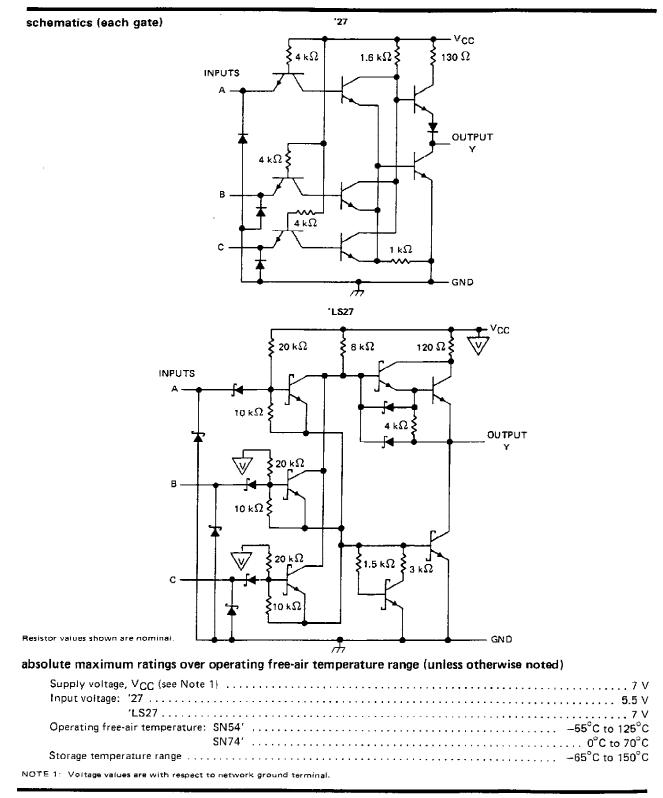
positive logic

 $Y = \overline{A + B + C}$ or $Y = \overline{A} \cdot \overline{B} \cdot \overline{C}$

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SN5427, SN54LS27, SN7427, SN74LS27 TRIPLE 3-INPUT POSITIVE-NOR GATES





recommended operating conditions

			SN5427			\$N7427			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	v	
VIH	High-level input voltage	2			2			v	
V _{IL}	Low-level input voltage			0,8			0.8	v	
I _{ОН}	High-level output current			0.8			- 0.8	mA	
¦0∟	Low-level output current			16			16	mΑ	
Т _А	Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT			SN5427	,				
TANAMETEN				MIN	TYP ‡	MAX	MIN	түр‡	MAX	UNIT
Vik	V _{CC} = MIN,	l ₁ = – 12 mA				- 1.5			- 1.5	v
⊻он	V _{CC} = MIN,	V _{IL} = 0.8 V,	I _{OH} = - 0.8 mA	2.4	3.4		2,4	3.4		v
Vol	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 16 mA		0.2	0.4		0.2	0.4	v
ţ _I	V _{CC} = MAX,	V ₁ = 5.5 V				1			1	mA
ін	V _{CC} = MAX,	V ₁ = 2.4 V			-	40			40	μA
կլ	V _{CC} = MAX,	Vi = 0.4 V				- 1.6			- 1.6	mA
los §	V _{CC} = MAX			- 20		- 55	- 18		- 55	ΜM
^I ССН	VCC = MAX,	VI = 0 V			10	16		10	16	mA
ICCL	V _{CC} = MAX,	See Note 2			16	26		16	26	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

2

‡ All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. § Not more than one output should be shorted at a time.

NOTE 2: One input at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN	түр	мах	UNIT
tPLH	A, B or C	v	R _L = 400 Ω,	C1 = 15 pF		10	15	ns
tpHL	A, 5 0 C		···L - 400 32,	of - 19 th		7	11	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

SN54LS27, SN74LS27 TRIPLE 3-INPUT POSITIVE-NOR GATES

recommended operating conditions

		s	SN54LS27			SN74LS27			
	·····	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V _{CC} Si	upply voltage	4.5	5	5.5	4.75	5	5.25	v	
V _{IH} H	igh-level input voltage	2			2			v	
VIL La	ow-level input voltage			0.7			0.8	V	
IOH H	igh-level output current			- 0.4			- 0.4	mΑ	
IOL LO	ow-level output current			4			В	mA	
	perating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST CONDITIONS †				27	S	7	LINIT	
PARAMETER		TEST CONDI	TIONS T	MIN	TYP‡	MAX	MIN	TYP ‡	MAX	UNIT
Viк	V _{CC} = MIN.	l _l = 18 mA				- 1.5			- 1.5	v
Vон	V _{CC} = MIN,	V _{IL} = MAX,	l _{OH} ≐ – 0.4 mA	2.5	3.4		2.7	3.4		v
	VCC = MIN,	V _{1H} = 2 V,	loL = 4 mA		0.25	0.4		0.25	0.4	v
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	lOL = 8 mA					0.35	0.5	Ŷ
lj lj	V _{CC} = MAX,	V1 = 7 V	· · · · · · · · · · · · · · · · · · ·			0.1			0.1	mA
Чн	VCC = MAX,	V∣ ≠ 2.7 V				20			20	μA
lι.	V _{CC} = MAX,	V _I ≠ 0.4 V				- 0.4			- 0.4	mA
IOS §	V _{CC} = MAX			- 20		- 100	20		- 100	mA
Іссн	V _{CC} = MAX,	V = 0 V			2	4		2	4	mА
^I CCL	VCC = MAX,	See Note 2			3.4	6.8		3.4	6.8	mA

t For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

* All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second. NOTE 2: One Input at 4.5 V, all others at GND.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	түр	МАХ	UNIT
tplh	A, B or C	v	$R_L = 2 k \Omega, \qquad C_l = 15$	- F		10	15	пs
^t ₽HL	A, B OF C	· · ·				10	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/30302B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302B2A	Samples
JM38510/30302BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
JM38510/30302BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
JM38510/30302BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
JM38510/30302BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
M38510/30302B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302B2A	Samples
M38510/30302B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302B2A	Samples
M38510/30302BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
M38510/30302BCA	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BCA	Samples
M38510/30302BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
M38510/30302BDA	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30302BDA	Samples
SN54LS27J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS27J	Samples
SN54LS27J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS27J	Samples
SN74LS27D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LS27	
SN74LS27D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI	0 to 70	LS27	
SN74LS27DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS27	Samples
SN74LS27DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS27	Samples
SN74LS27N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS27N	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS27N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS27N	Samples
SN74LS27NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS27	Samples
SN74LS27NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS27	Samples
SNJ54LS27FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 27FK	Samples
SNJ54LS27FK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 27FK	Samples
SNJ54LS27J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27J	Samples
SNJ54LS27J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27J	Samples
SNJ54LS27W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27W	Samples
SNJ54LS27W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS27W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.



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PACKAGE OPTION ADDENDUM

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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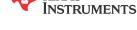
OTHER QUALIFIED VERSIONS OF SN54LS27, SN74LS27 :

Catalog : SN74LS27

• Military : SN54LS27

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*Al	l dimensions are nominal												
	Device	•	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	SN74LS27DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
	SN74LS27NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

16-Apr-2024



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS27DR	SOIC	D	14	2500	356.0	356.0	35.0
SN74LS27NSR	SO	NS	14	2000	356.0	356.0	35.0

TEXAS INSTRUMENTS

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16-Apr-2024

TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
JM38510/30302B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/30302BDA	W	CFP	14	25	506.98	26.16	6220	NA
M38510/30302B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/30302BDA	W	CFP	14	25	506.98	26.16	6220	NA
SN74LS27N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS27N	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS27FK	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54LS27W	W	CFP	14	25	506.98	26.16	6220	NA

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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